General Description

The MAX7231/32/33/34 family of integrated circuits is a complete line of triplexed liquid crystal display (LCD) drivers. These devices interface microprocessors (or digital systems) to multiplexed numeric and alphanumeric displays. The MAX7231 drives 8 digits and accepts data in a parallel format. The MAX7232 drives 10 digits and accepts data in a serial format. Both devices feature two independent annunciators per digit. The MAX7233 drives 4 alphanumeric 18 segment characters. The MAX7234 drives 5 alphanumeric 18 segment characters.

Each device includes an input buffer, digit address decoding circuitry and mask-programmed ROM allowing six bits of input data to be decoded into 64 independent combinations of the output segments of each digit. This offloads the microprocessor system, reducing the ROM space and CPU time needed to service a display.

Applications

These low-power LCD drivers are ideal for microprocessor-based portable applications where power consumption is a primary concern. Many applications also take advantage of the annunciator drive capability, which allows unlimited variations of display layout.

Portable instrumentation Industrial equipment Telecommunications Medical equipment Panel Meters Machine control

Features

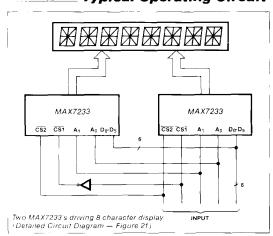
- MAX7231 drives 8 digits/7 segments; parallel input format; 2 annunciators per digit
- MAX7232 drives 10 digits/7 segments; serial input format; 2 annunciators per digit
- MAX7233 drives 4 alphanumeric characters/ 18 segments; parallel input format
- MAX7234 drives 5 alphanumeric characters/ 18 segments; serial input format
- On-chip oscillator
- Direct interface to microprocessors
- Monolithic, Low Power CMOS Design

Ordering Information

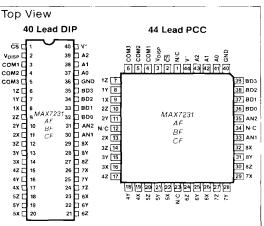
PART	TEMP. RANGE	PACKAGE
MAX7231AFIPL	-20°C to +85°C	40 Lead Plastic DIP
MAX7231BFIPL	-20°C to -85°C	40 Lead Plastic DIP
MAX7231CFIPL	-20°C to +85°C	40 Lead Plastic DIP
MAX7232AFIPL	-20°C to ⋅85°C	40 Lead Plastic DIP
MAX7232BFIPL	-20°C to +85°C	40 Lead Plastic DIP
MAX7232CFIPL	-20°C to +85°C	40 Lead Plastic DIP
MAX7233AFIPL	-20°C to +85°C	40 Lead Plastic DIP
MAX7233BFIPL	-20°C to +85°C	40 Lead Plastic DIP
MAX7234AFIPL	-20°C to +85°C	40 Lead Plastic DIF
MAX7234BFIPL	-20°C to +85°C	40 Lead Plastic DIF

Ordering information continued on next page

Typical Operating Circuit



Pin Configuration



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Maxim Integrated Products 1

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OPTION TABLE

DEVICE	OUTPUT CODE	ANNUNCIATOR LOCATIONS	INPUT	√OUTPUT
MAX7231AF MAX7231BF	Hexdecimal Code B	Both Annunicators on COM3	Parallel Entry 4 bit Data	8 Digits plus
MAX7231CF	Code B	1 Annunciator COM1 1 Annunciator COM3	2 bit Annunciators 3 bit Address	16 Annunciators
MAX7232AF	Hexadecimal	Both Annunciators	Serial Entry	10 Digits
MAX7232BF	Code B	on COM3	4 bit Data 2 Bit Annunciators	plus 20 Annunciators
MAX7232CF	Code B	1 Annunciator COM1 1 Annunciator COM3	4 bit Address	
MAX7233AF	64 Character (ASCII) 18 Segment (Half width numbers)	No independent Annunciators	Parallel Entry 6 bit (ASCII) Data 2 bit Address	Four Characters
MAX7233BF 64 Character (ASCII) 18 Segment (Full width numbers)		No Independent Annunciators	Parallel Entry 6 bit (ASCII) Data 2 bit Address	Four Characters
MAX7234AF 64 Character (ASCII) 18 Segment (Half width numbers)		Annunciators Data		Five Characters
MAX7234BF 64 Character (ASCII) 18 Segment (Full width numbers)		No Independent Annunciators	Serial Entry 6 bit (ASCII) Data 3 bit Address	Five Characters

Pin Configuration **Ordering Information** (Continued from front page) Top View 44 Lead PCC TEMP. RANGE **PACKAGE** PART COM2 COM1 COM1 SOMM COM1 SINHUT SINHU 44 Lead Plastic Chip Carrier MAX7231AFIQ -20°C to +85°C 44 Lead Plastic Chip Carrier MAX7231BFIQ -20°C to +85°C MAX7231CFIQ -20°C to +85°C 44 Lead Plastic Chip Carrier 44 Lead Plastic Chip Carrier MAX7232AFIQ -20°C to +85°C 1X 9 2Z 10 37 10Z 36 9X MAX7232BFIQ -20°C to +85°C 44 Lead Plastic Chip Carrier MAX7232 2Y 11 35 9Y 34 N/C AF BF CF 44 Lead Plastic Chip Carrier MAX7232CFIQ -20°C to +85°C 2X 13 33] 9Z MAX7233AFIQ -20°C to +85°C 44 Lead Plastic Chip Carrier 32 8X 31 8Y 30 8Z MAX7233BFIQ -20°C to +85°C 44 Lead Plastic Chip Carrier 3Y 15 MAX7234AFIQ -20°C to +85°C 44 Lead Plastic Chip Carrier 44 Lead Plastic Chip Carrier MAX7234BFIQ -20°C to +85°C 40 Lead DIP 40 Lead DIP 40 Lead DIP DATA CLOCK INPUT [40 V V 39 WRITE INPUT 38 DATA INPUT 37 DATA ACCEPTED 36 GND OUTPUT 35 DIOX 34 DIOX CS1 □ 40 | V¹ 39 | CS2 38 | A1 37 | A0 36 | GND 35 | D5 34 | D4 39 WRITE INPUT 38 DATA INPUT 37 DATA ACCEPTED 36 GND OUTPUT V_{DISP} C V_{DISP} [COM1 COM2 C COM2 C 1Z [1Y [1X [12 | 17 | 1X | 5U 5V 33 D3 32 D2 31 D1 30 D0 29 D4U 28 D4V 27 D4W 26 D4X 25 D4Y 24 D4Z 23 D3U 22 D3V 21 D3W 5W 5X 55Y 57 52 40 40 33 32 31 30 29 28 27 26 25 24 23 233 | 10Z 232 | 9X 31 | 9Y 30 | 9Z 29 | 8X 28 | 8Y 27 | 8Z 26 | 7X 25 | 7Y 24 | 7Z Бзυ

Continued on last page of data sheet

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ABSOLUTE MAXIMUM RATINGS

Power Dissipation (Note 1) 0.5 W @ 85°C Supply Voltage (V+) 6.5V Input Voltage (Note 2) -0.3V ≤ V_{IN} ≤ 6.5V Display Voltage (Note 2) -0.3V to V+ 0.3V Operating Temperature Range -20°C to +85°C Storage Temperature Range -65°C to +160°C Soldering Temperature (10 seconds) +300°C

Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not limited. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. device reliability.

ELECTRICAL CHARACTERISTICS (V+ = +5V ±10%, T_A = -20°C to +85°C unless noted)

PARAMETER	SYMBOL	CONDITIONS/DESCRIPTION	MIN	TYP	MAX	UNITS	
Power Supply Voltage	V+		4.5		5.5	V	
Data Retention Supply Voltage	V+	Guaranteed Retention at 2V	2	1.6		V	
Logic Supply Current	[+	Current from V ⁺ to Ground excluding Display, V _{DISP} = 2V		30	100	μΑ	
Shutdown Total Current	Is	V _{DISP} Pin 2 Open, T _A = +25°C		1	10	μА	
Display Voltage Range	VDISP	Ground $\leq V_{DISP} \leq V^+$	0		V+	٧	
Display Voltage Setup Current	IDISP	$V_{DISP} = (V^+ - 3V)$, Current from V^+ to V_{DISP} On-Chip (Note 3), $T_A = +25^{\circ}$ C		15	25	μΑ	
Display Voltage Setup Resistor Value	Roise	One of Three Identical Resistors in String (Note 3), TA = +25°C	40	75		kΩ	
DC Component of Display Signals		Sample Test only, V _{DISP} = 0V		1/4	1	% (V+-V _{DISP})	
Display Frame Rate	folse	See Figure 2, T _A = +25°C	60	90	120	Hz	
Input Low Level (Note 3)	VIL	MAX7231, MAX7233 MAX7232, MAX7234			0.8	V	
Input High Level (Note 3)	VIH	Pins 1, 30-35, 37-39 Pins 1, 38, 39	2.0			V	
Input Leakage	lilk	MAX7231, MAX7233 MAX7232, MAX7234		0.1	1	μΑ	
Input Capacitance	Cin	Pins 1, 30-35, 37-39 Pins 1, 38, 39		5		pF	
Output Low Level	Vol	Pin 37, MAX7232, MAX7234, I _{OL} = 1mA,			0.4	V	
Output High Level	Voн	$V^{+} = 4.5V$, $I_{OH} = -500\mu A$	4.1			V	

AC CHARACTERISTICS V+ = 5V, TA = 25°C, 0-3V INPUT SWINGS PARALLEL INPUT (MAX7231, MAX7233) See Figure 5

PARAMETER	SYMBOL	CONDITIONS/DESCRIPTION	MIN	TYP	MAX	UNITS
Chip Select Pulse Width	tcs		500	350		ns
Address/Data Setup Time	tds		350			ns
Address/Data Hold Time	t _{dh}		0	-20		ns
Inter-Chip Select Time	tics		3.5			μS

AC CHARACTERISTICS 0-3V INPUT SWINGS SERIAL INPUT (MAX7232, MAX7234) See Figures 6, 7, 8

SYMBOL	CONDITIONS/DESCRIPTION	MIN	TYP	MAX	UNITS
t _{cl}		350			ns
t _{cl}		1			μS
tds		350			ns
tdh		0	-20		ns
twp		500	350		ns
t _{wll}		4.0			μS
todi				1	μS
todh			1.5	3	μS
tows		350			ns
	tel tel tds tdh twp twll todl	t _{Cl} t _{Cl} tts tds tdh twp twll todl	tcl 350 tcl 1 tds 350 tdh 0 twp 500 twll 4.0 todl todh	tcl 350 tcl 1 tds 350 tdh 0 -20 twp 500 350 twll 4.0 todl 1.5	tcl 350 tcl 1 tds 350 tdh 0 twp 500 350 350 twll 4.0 todl 1 todh 1.5 330 350 1 1.5 330 350 1 1.5 330 350 1 1.5 330 350 1 1.5 3 3

Note 1: This limit refers to that of the package and will not be obtained during normal operation.

Note 2: Due to the SCR structure inherent in these devices, connecting any display terminal or the display voltage terminal to a voltage outside the power supply to the chip may cause destructive device latchup. The digital inputs should never be connected to a voltage less than -0.3 volts below ground, but may be connected to voltages above V+ but not more than 6.5 volts above GND.

Note 3: V+ = 5V, T_A = +25°C.



TERMINAL DEFINITIONS

MAX7231 PARALLEL INPUT NUMERIC DISPLAY

TERMINAL	PIN NO.	DESCI	RIPTION	FUNCTION		
AN1 AN2	30 31	Annunciator 1 Cor Annunciator 2 Cor		High = ON Low = OFF	See Table 1	
BD0 BD1 BD2 BD3	32 33 34 35	Least Significant Most Significant	4 Bit Binary Data Inputs	Input Data (See Table 2)	HIGH – Logical One (1)	
A0 A1 A2	37 38 39	Least Significant Most Significant	3 Bit Digit Address Inputs	Input Address (See Table 4)	LOW = Logical Zero (0)	
CS	1	Data Input Strobe/ (Note 3)	Chip Select	Trailing (Positive going) edge latches data, causes data input to be decoded and sent out to addressed digit		

Note 3: CS has a special "mid-level" sense circuit that establishes a test mode if it is held near 3V for several msec. Inadvertent triggering of this mode can be avoided by pulling it high when inactive, and driving it with fast rise and fall times.

MAX7233 PARALLEL INPUT ALPHA DISPLAY

TERMINAL	PIN NO.	DESCRIPTION		FUNCTION		
D0 D1 D2 D3 D4 D5	30 31 32 33 34 35	Least Significant 6 Bit (ASCII) Data Inputs Most Significant	Input Data (See Table 3)	HIGH = Logical One (1) LOW = Logical Zero (0)		
A0 A1	37 3	Least Significant Most Significant Address Inputs	Input Add. (See Table 5)			
CS1 CS2	39 1	Chip Select Inputs (Note 3)	Both Inputs LOW, load data into input latches. Rising edge of either input causes data to be latched, decoded and sent out to addressed character.			

MAX7232 and MAX7234 SERIAL DATA AND ADDRESS INPUT

TERMINAL	PIN NO.	DESCRIPTION	FUNCTION
		Data + Address Shift Register Input	HIGH - Logical One (1) LOW - Logical Zero (0)
		39 Decode, Output, and Reset Strobe When DATA ACCEPTED Output i positive going edge of WRITE cau in shift register to be decoded an addressed digit, then shift registe control logic is reset. When DATA ACCEPTED Output is HIGH, positive gdg of WRITE triggers reset only	
Data Clock 1 Data Shift Register and Control Logic Clock			Positive going edge advances data in shift register. MAX7232: Eleventh edge resets shift register and control logic. MAX7234: Tenth edge resets shift register and control logic.
DATA 37 Handshake Output ACCEPTED Output		Handshake Output	Output LOW when correct number of bits entered into shift register; MAX7232: 8, 9 or 10 bits. MAX7234: 9 bits.

ALL DEVICES

TERMINAL	PIN NO.	DESCRIPTION	FUNCTION
Display 2 Voltage V _{DISP} 2		Negative end of on-chip resistor string used to generate intermediate voltage levels for display. Shutdown Input.	Display voltage control. When open (or less than 1V from V ⁺) chip is shutdown; oscillator stops, all display pins to V ⁺ .
Common Line Driver Outputs	3,4,5		Drive display commons, or rows.
Segment Line Driver Outputs	nent Line 6-29 (On MAX7231/33)		Drive display segments, or columns.
V+	40	Positive Supply	
GND	36	Ground	

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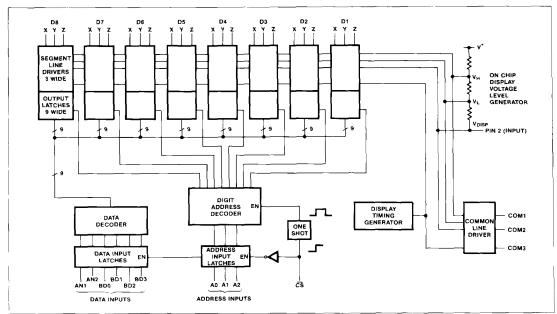


Figure 1. Block Diagram of MAX7231.

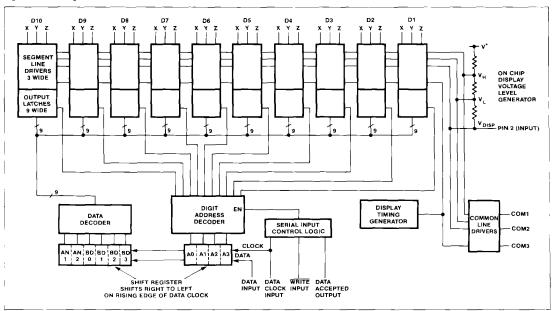


Figure 2. Block Diagram of MAX7232

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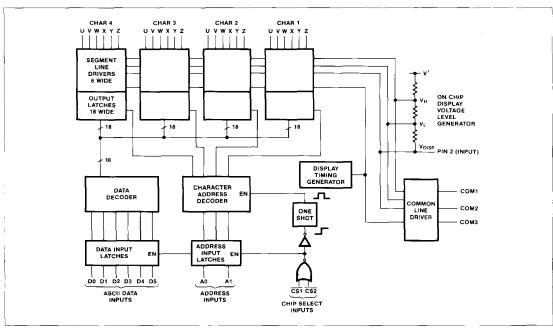


Figure 3. Block Diagram of MAX7233

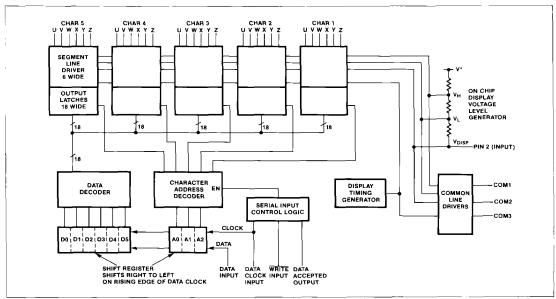


Figure 4. Block Diagram of MAX7234

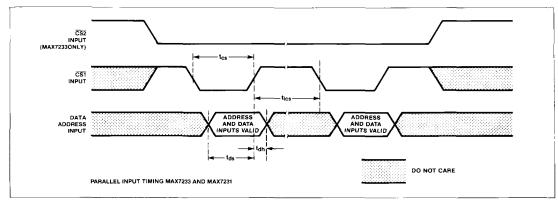


Figure 5. Parallel Input Timing

Detailed Description

Parallel Input Interface

The MAX7231 and MAX7233 have a parallel interface allowing direct parallel connection to microprocessors. The address and data bits are latched on the positive going edge of the Chip Select. The positive going edge of Chip Select also triggers an internal monostable that enables the address decoder and latches the decoded data into the digit/character output latches.

Figure 5 shows the timing requirements for the parallel input devices (7231 and 7233). To ensure that the new data does not appear at the decoder inputs before the previous decoded data is written to the outputs, there is a minimum time required between CHIP SELECT pulses.

Serial Input Interface

A WRITE pulse while Data Accepted Output is high will reset the serial input control logic, but will not latch any data. A WRITE pulse while Data Accepted Output is low will cause the MAX7232 and MAX7234 to decode the data, latch the data into the output latches and then reset the serial input control logic.

This assures that each data bit will be entered into the correct position in the shift register, depending on the subsequent data clock inputs. The MAX7232's Data Accepted Output goes low after 8 Data Clock pulses, whereas the MAX7234's Data Accepted Output goes low after 9 Data Clock Inpulses. Further Data Clock pulses occuring before a WRITE pulse will cause the Data Accepted Output to go high after 11 Data Clock pulses in the MAX7232 and the 10 Data Clock pulses in the MAX7234. In both cases, the serial input control logic is also reset when Data Accepted goes high.

The serial input timing diagram shown in Figure 6 illustrates the recommended procedure for entering data.

Note that the eleventh clock resets the shift register and control logic for the MAX7232, but the Data Accepted Output goes low after the eighth clock. As Figure 7 illustrates, this allows the user to reduce the data to eight bits. The MAX7232 then writes to the 7 segment display, but leaves the annunciators off. Nine Bits are clocked in if only AN2 is turned on.

The control logic of the MAX7234 is similar to the MAX7232, but nine bits are always required. As illustrated in Figure 8, the data bits are only latched if the WRITE input occurs after the ninth data bit has been entered and Data Accepted Output is low.



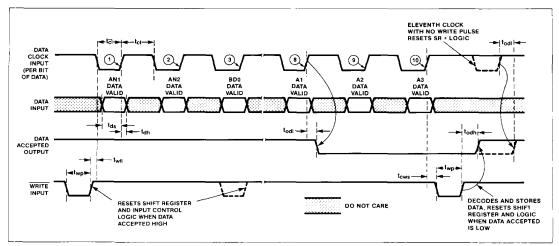


Figure 6. One Digit Timing Diagram for the MAX7232, Writing Both Annunciators.

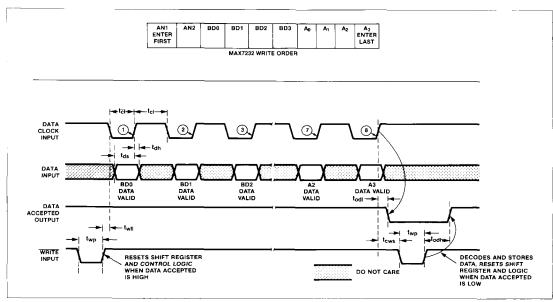


Figure 7. Input Timing Diagram of the MAX7232. Both Annunciators OFF.

s ______/VI/XI/VI

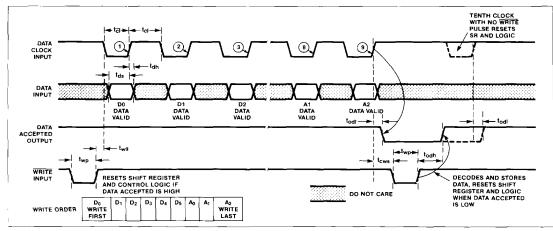


Figure 8. One Character Input Timing Diagram of the MAX7234.

Temperature Compensation

Temperature Effects

Temperature affects the performance of liquid crystal displays (LCD's) in two ways. As the display temperature drops, the response time of the display becomes longer. At very low temperatures, some displays may take several seconds to change to a new character. However, high-speed liquid crystal materials are available for low temperature environments.

Temperature has a significant effect on the variation of liquid crystal threshold voltage. The peak voltage (VP) required to turn on the display has a temperature coefficient of -7 to -14 mV/°C for typical liquid crystal materials used in multiplexed LCD's. This means that as the temperature increases, the threshold voltage

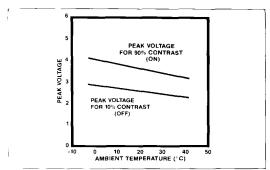


Figure 9. Temperature Dependence of Liquid Crystal Threshold.

decreases. Figure 9 illustrates the dependence of peak voltage (VP) on temperature for the same liquid crystal material described in Figure 10. Assuming a fixed value for VP, OFF segments begin to be visible when the threshold voltage drops below VP/3. To avoid this problem at high temperature, VP may be set at a fixed voltage chosen to make the RMS OFF voltage, VP/3, just below the threshold voltage at the highest temperature expected. This is appropriate where display temperatures do not vary widely.

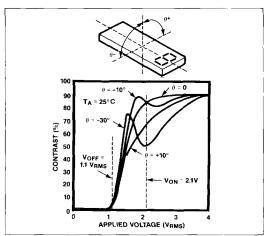


Figure 10. Applied RMS Voltage vs. Contrast

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Display Voltage

An internal resistor string of three equal value resistors is used to generate the display drive voltages. One end of the string is available at Pin 2 (VDISP) and the other end is connected to V+ on the chip. Pin 2, the user's input, allows the display voltage to be optimized for a particular liquid crystal material. Note that Vp should be three times the threshold voltage for the liquid crystal material used (Vp = V+ - VDISP). To avoid device latchup and possible destruction of the chip, never drive Pin 2 below Ground or above V+.

Figure 11 illustrates a simple method of generating a display voltage suitable for a particular display. A potentiometer with a maximum value of 200kΩ connected from Pin 2 to Ground gives sufficient range adjustment to suit most displays. Due to the positive temperature coefficient of the resistors on-chip, this method for generating display voltage should be used only in applications where the temperature variation of the chip and display will not vary more than ±5°C (15°F). The power supply voltage also effects the display voltage.

The chip may be operated at the display voltage with VDISP connected to Ground in battery powered applications where the display voltage is the same as the battery voltage (typically 3 to 4.5 volts). The inputs of the chip are designed such that they may be driven above V+ without damage. This allows the chip and display to operate at a regulated 3V while its inputs are driven by a microprocessor that is operating at a less well controlled 5V supply. Under no circumstances should the inputs be driven more than 6.5V above Ground. Independent adjustment of both voltage and temperature compensation is illustrated in Figure 12. Temperature compensation is performed by the ICL7663.

Another method of setting up a display voltage is illustrated in Figure 13. The five diodes (1N914 or equivalent), each have a forward drop of approximately 0.65V, with 20 (μA) at room temperature. This configuration is suitable for the 3V display using the material properties as shown in Figures 9 and 10. More diodes may be added for higher voltage displays. Each diode has a negative temperature

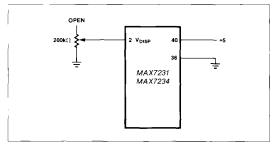


Figure 11. Simple Display Voltage Adjustment

coefficient of ~2mV/°C (5 in series gives ~10mV/°C). Consequently, this circuit will provide reasonable temperature compensation.

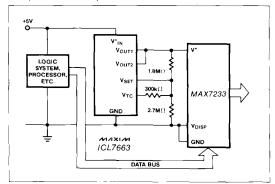


Figure 12. Flexible Temperature Compensation.

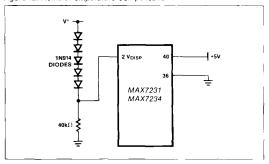


Figure 13. Diode String VDISP Generator.

_Triplexing

The connection diagram for a typical 7-segment display font with 2 annunciators is illustrated in Figure 15. The MAX7231 and MAX7232 (A and B suffix versions) numeric display drivers use this configuration. The voltage waveforms of the common lines and one segment line are illustrated in Figure 14. The "Y" segment line has been chosen as an example. This line intersects with COM1 to form the "A" segment, COM2 to form the "G" segment, and COM3 to form the "D" segment. Four different ON/OFF combinations of the "A", "G" and "D" segments and their corresponding waveforms of the "Y" segment line are illustrated in Figure 14. The schematic diagram in Figure 16 shows that each intersection acts as a capacitance from segment line to common line. Figure 17 illustrates the voltage across the "G" segment for the same four combinations of ON/OFF segments shown in Figure 14.

The RMS voltage across the segment determines the degree of polarization for the liquid crystal material and thus the contrast of the segment. The

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RMS OFF voltage is always Vp/3, whereas the RMS ON voltage is always 1.92 Vp/3. This is illustrated in Figure 17. The ratio of RMS ON to OFF voltage is fixed at 1.92 for a triplexed liquid crystal display.

Contrast vs. applied RMS voltage is shown in Figure 10. With a Vp of 3.1V, the RMS ON voltage is 2.1V and the RMS OFF voltage is 1.1V. The OFF segment will have a contrast of less than 5%, while the ON segments will have greater than 85% contrast.

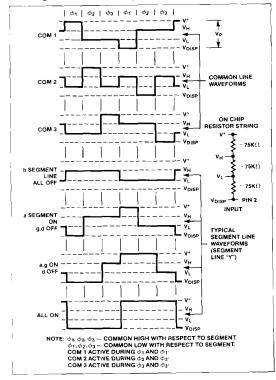


Figure 14. Display Voltage Waveforms.

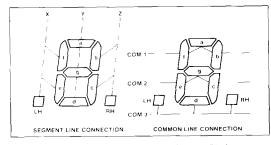


Figure 15. Connection Diagrams for Typical 7-Segment Displays.

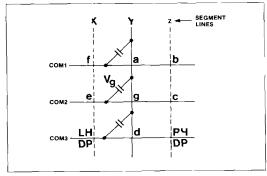


Figure 16. Schematic of Display.

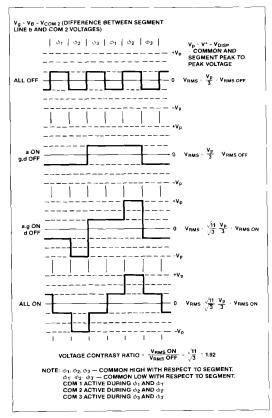


Figure 17. Voltage Waveforms on Segment g (Vg).

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Output Codes and Display Fonts

The MAX7231 and MAX7232 numeric display drivers are programmed to drive 7-segment displays plus 2 annunciators per digit. Refer to Table 1 for annunciator input controls. The display connections for one digit are shown in Figure 18. Both annunciators are placed on COM3 on the "A" and "B" suffix devices. The "A" devices offer a "hexadecimal" 7-segment output, while the "B" devices offer "Code B" outputs. This is illustrated in Table 2. Figure 19 illustrates the "C" device configuration. The Left

Table 1: Annunciator Decoding

	DE PUT	DISPLAY	OUTPUT
AN AN 1		MAX7231 A/B MAX7232 A/B BOTH ANNUNCIATORS ON COM 3	MAX7231C MAX7232C LH ANNUNCIATOR COM 1 RH ANNUNCIATOR COM 3
0	0	8	8
0	1	.8	8.
1	0	8.	8
1	1	.8.	8.

Table 2: Binary Data Decoding (MAX7231/MAX7232)

	CO INP			PLAY PUT	
BD 3	BD 2	BD 1	BD 0	HEX	CODE B
0	0	0	0	U	0
0	0	0	1	1	7
0	0	1	0	2	<i>2</i>
0	0	1	1	3	3
0	1	0	0	4	7
0	1	0	1	5 8	5 8
0	1	1	0	5	8
0	1	1	1	7	7
1	0	0	0	8	8 9
1	0	0	1	9	9
1	0	1	0	R	-
1	0	1	1	Ь	Ε
1	1	0	0	Ε	Н
1	1	0	1	d	L
1	1	1	0	Ε	Р
1	1	1	1	F	BLANK

hand annunciator is placed on COM1 (AN2) and the right hand annunciator (usually a decimal point) is placed on COM3 (AN1). Only a "Code B" output is offered for the "C" devices.

Both the MAX7233 and MAX7234 are supplied in "A" and "B" versions, decoding an ASCII 6-bit subset to an 18-segment display, with 16 "flag" segments and 2 "dots". Figure 20 illustrates the layout for a single character. The "A" devices have numbers which are half-width and the "B" devices have full-width numbers. Refer to Table 3 for output decoding.

Table 3: Data Decoding — 18 Segment (MAX7233/MAX7234)

CODE INPUT			DISPLAY OUTPUT					
C	ODE	INPU	Т	D5 D4 VERSION VERS			B VERSION	
D3	D2	D1	D0	0,0	0,1	1,0		,1
0	0	0	0	C	L			[]
0	0	0	1	H		-!-		1
0	0	1	0	\blacksquare	R	11	2	3 3 4
0	0	1	1		5	Ŧ	3	3
0	1	0	0	I	T	5	4	4
0	1	0	1	E	Ш	另	5	55 65
0	1	1	0	F	V	Z	5	£5
0	1	1	1	G	W	Ī		7
1	0	0	0	Н	Χ	<	Е	8
1	0	0	1	I	Y	>	9	53
1	0	1	0	J	Ζ	*		;
1	0	1	1	К	[+	Ĺ .	;
1	1	0	0	L	1	/	۷	
1	1	0	1	M		_	=	
1	1	1	0	N	7		7	
1	1	1	1		+	/		7

Table 4: Address Decoding (MAX7231/7232)

	CODE	DISPLAY OUTPUT		
MAX 7232 ONLY	A2	A 1	AO	DIGIT SELECTED
0	0	0	0	D1
0	0	0	1	D2
0	0	1	0	D3
0	0	1	1	D4
0	1	0	0	D5
0	1	0	1	D6
0	1	1	0	D7
0	1	1	1	D8
1	0	0	0	D9
1	0	0	1	D10
1	0	1	0	NONE
1	0	1	1	NONE
1	1	0	0	NONE
1	1	0	1	NONE
1	1	1	0	NONE
1	1	1	1	NONE

Table 5: Address Decoding (MAX7233/7234)

	CODE INPUT	DIGIT SELECTED	
MAX 7234 ONLY			
A2	A1	A 0	
0	0	0	D1
0	0	1	D2
0	1	0	D3
0	1	1	D4
1	0	0	D5
1	0	1	NONE
1	1	0	NONE
1	1	1	NONE

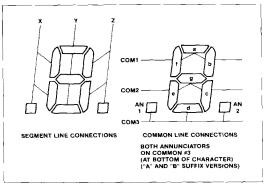


Figure 18. Display Fonts for MAX7231 and 7232. (Suffix Versions "A" and "B").

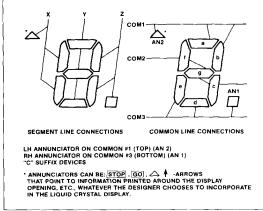


Figure 19. Display Fonts for MAX7231 and 7232. (Suffix Version "C").

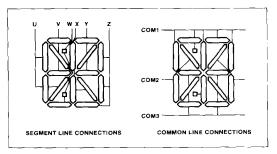


Figure 20. Display Fonts for MAX7233 and 7234. (18-Segment Alphanumeric).

NIXIXI

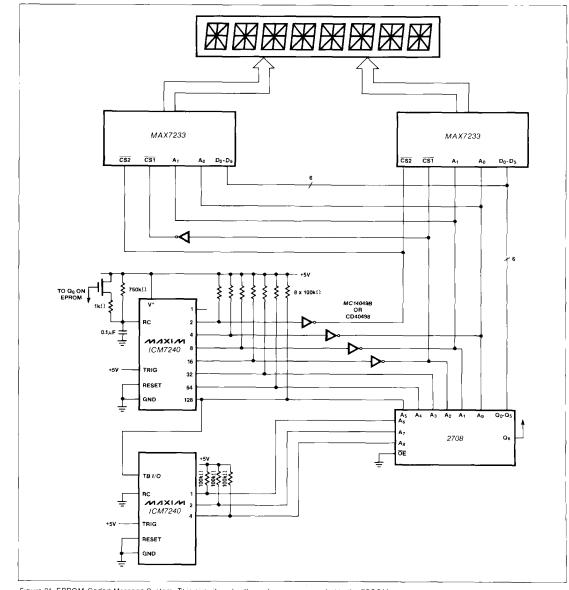


Figure 21. EPROM-Coded Message System. This circuit cycles through a message coded in the EPROM, pausing at the end of each line, or whenever coded on O₆.

14 ______/VI/XI/VI

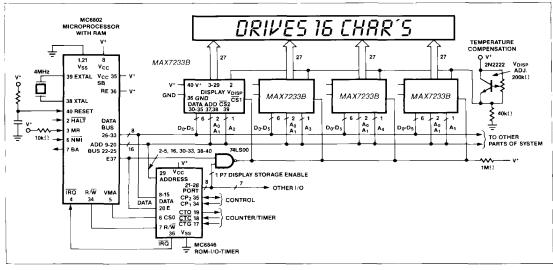
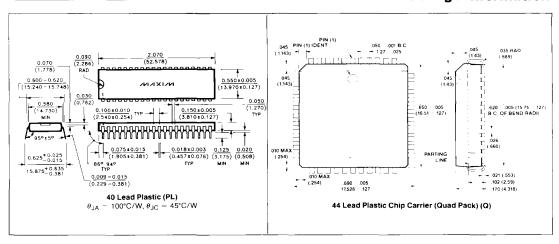
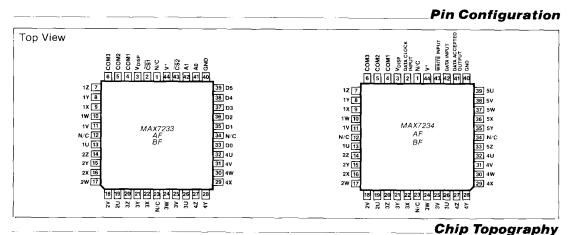
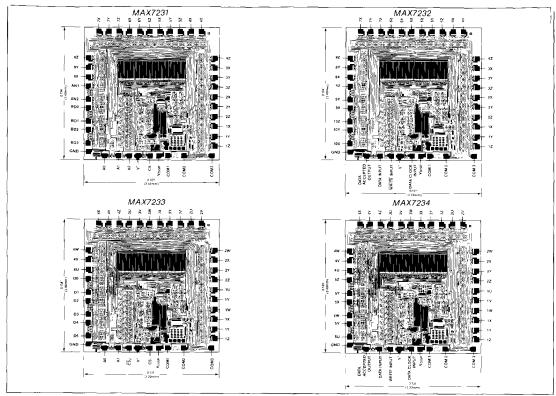


Figure 22. MC6802 Microprocessor with 16 Character 16 Segment ASCII Liquid Crystal Display.

Package Information







Maxim cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in a Maxim product. No circuit patent licenses are implied. Maxim reserves the right to change the circuitry and specifications without notice at any time.

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